

Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Breakdown Voltage, BV_{CEO}	350	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation ¹ (Each)	150	mW
Phototransistor Power Dissipation ² (Each)	150	mW
Isolation Voltage, Input to Output	3750	V_{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

² Derate linearly 1.5 mW / °C

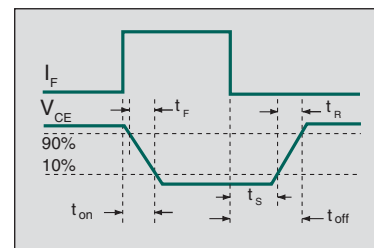
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

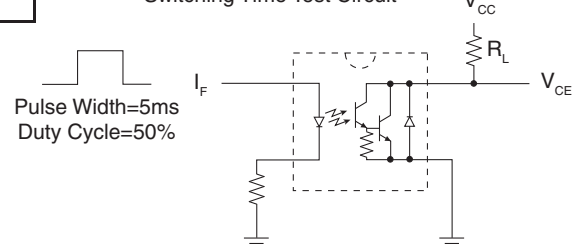
Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Phototransistor Breakdown Voltage	$I_{CEO}=100\mu A$	BV_{CEO}	350	-	-	V_P
Emitter-Collector Breakdown Voltage	$I_E=0.1mA$	BV_{ECO}	0.3	-	-	V
Phototransistor Output (Dark) Current	$V_{CEO}=200V, I_F=0mA$	I_{CEO}	-	-	100	nA
Saturation Voltage	$I_C=10mA, I_F=1mA$	$V_{CE(sat)}$	-	-	1	V
	$I_C=100mA, I_F=10mA$		-	-	1.2	V
Current Transfer Ratio	$I_F=1mA, V_{CE}=1V$	CTR	1000	5500	8000	%
Output Capacitance	$V_{CEO}=50V, f=1MHz$	C_{OUT}	-	13	-	pF
Input Characteristics						
Input Control Current	$I_C=10mA, V_{CE}=1V$	I_F	-	0.07	1	mA
Input Voltage Drop	$I_F=5mA$	V_F	0.9	1.2	1.4	V
Input Reverse Current	$V_R=5V$	I_R	-	-	10	μA
Common Characteristics						
Input to Output Capacitance	-	C_{IO}	-	3	-	pF

Switching Characteristics @ 25°C

Characteristic	Symbol	Test Condition	Typ	Units
Rise Time	t_R	$V_{CC}=10V$ $I_F=10mA$ $R_L=100\Omega$	40	μs
Fall Time	t_F		5	
Turn-On Time	t_{on}		5	
Storage Time	t_S		20	
Turn-Off Time	t_{off}		60	
Turn-On Time	t_{on}	$V_{CC}=10V$ $I_F=16mA$ $R_L=180\Omega$	1	
Storage Time	t_S		40	
Turn-Off Time	t_{off}		80	

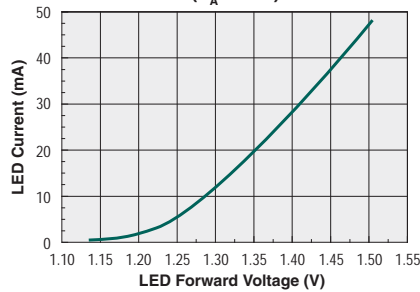


Switching Time Test Circuit

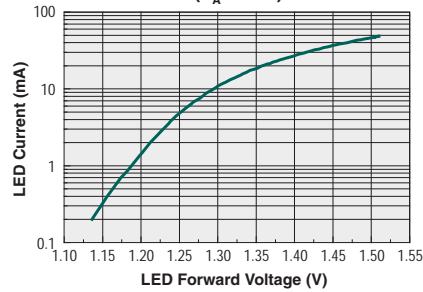


PERFORMANCE DATA*

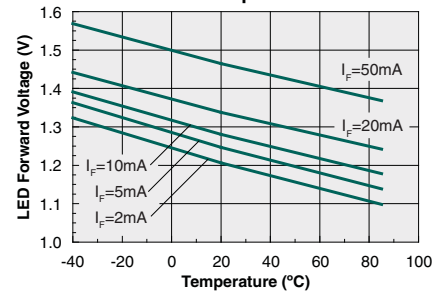
LED Current (I_F) vs.
LED Forward Voltage (V_F)
($T_A=25^\circ\text{C}$)



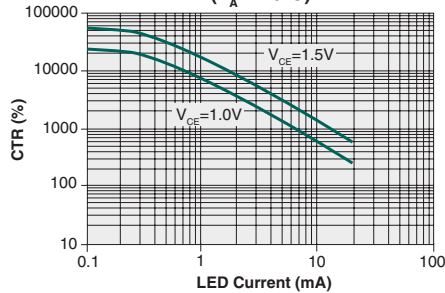
LED Current (I_F) vs.
LED Forward Voltage (V_F)
($T_A=25^\circ\text{C}$)



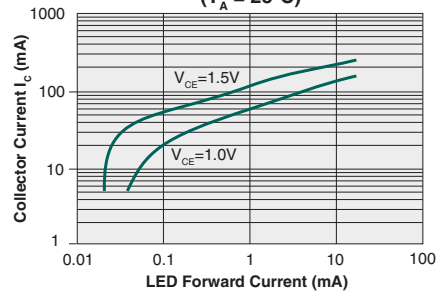
LED Forward Voltage
vs. Temperature



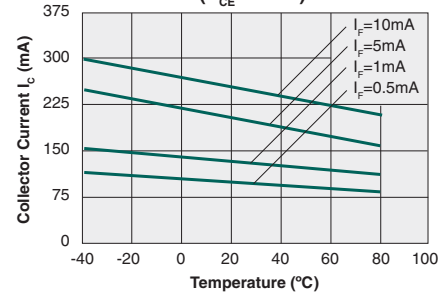
CTR vs. LED Current (I_F)
($T_A = 25^\circ\text{C}$)



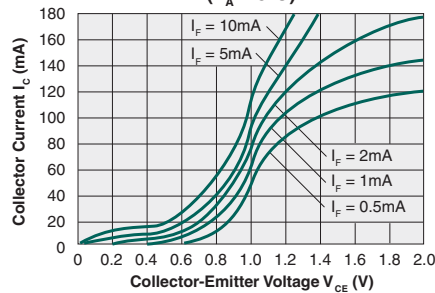
Collector Current vs. LED Current (I_F)
($T_A = 25^\circ\text{C}$)



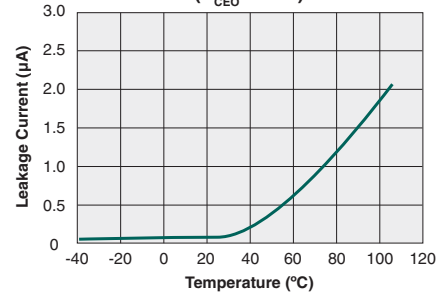
Collector Current vs. Temperature
($V_{CE} = 1.2\text{V}$)



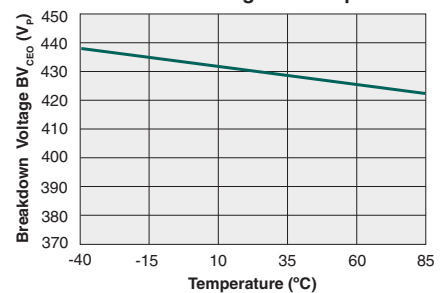
Collector Current vs.
Collector-Emitter Voltage
($T_A=25^\circ\text{C}$)



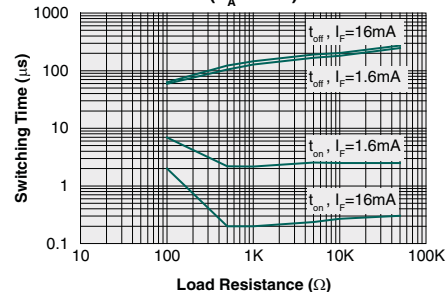
Leakage vs. Temperature
($V_{CE0}=350\text{V}$)



Breakdown Voltage vs. Temperature



Switching Time vs. Load Resistance
($T_A=25^\circ\text{C}$)



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1302G / CPC1302GS	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1302G / CPC1302GS	250°C for 30 seconds

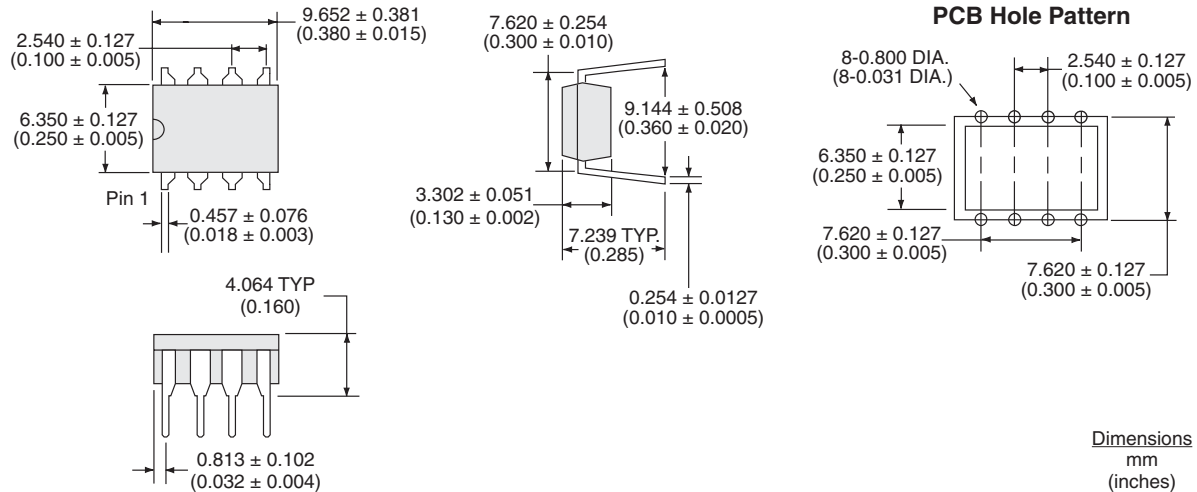
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

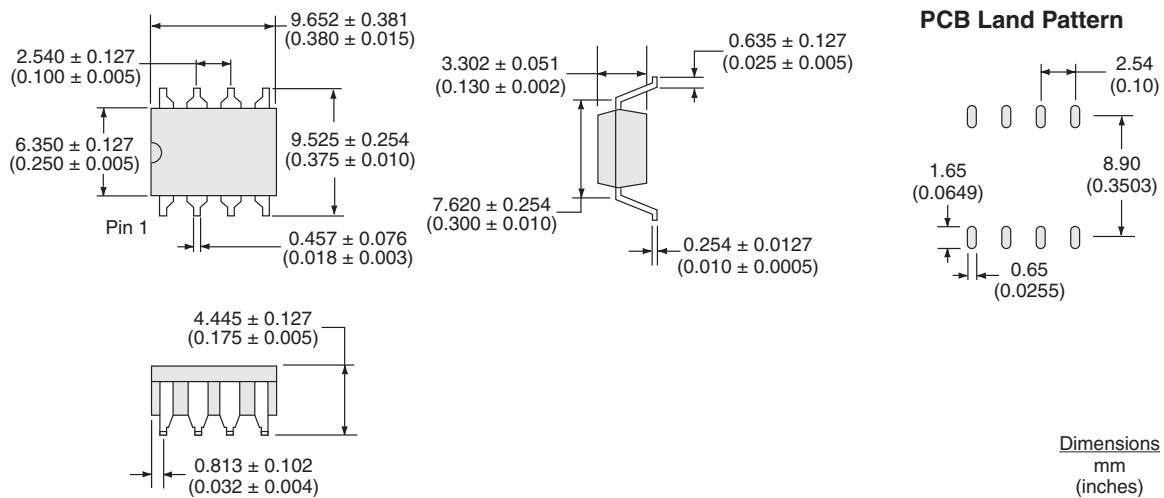


MECHANICAL DIMENSIONS

CPC1302G

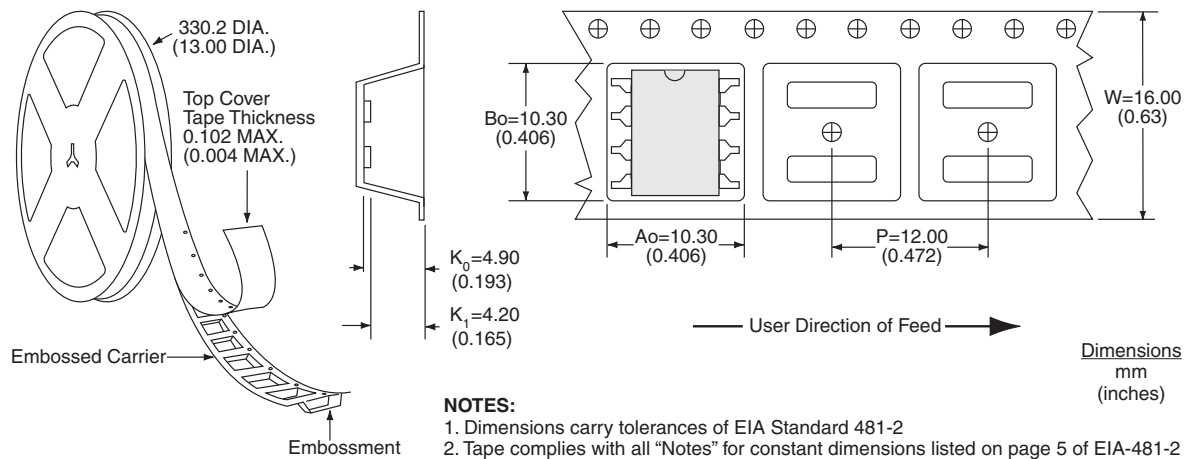


CPC1302GS



MECHANICAL DIMENSIONS

CPC1302GSTR Tape & Reel



For additional information please visit our website at: www.ixysic.com

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.